1N5817 and 1N5819 are Preferred Devices

Axial Lead Rectifiers

This series employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

Features

- Extremely Low V_F
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16 in from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- These devices are manufactured with a Pb–Free external lead finish only*

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Polarity: Cathode Indicated by Polarity Band



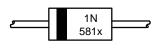
ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 1.0 AMPERE 20, 30 and 40 VOLTS



MARKING DIAGRAM



1N581x = Device Code x = 7, 8 or 9

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

Rating	Symbol	1N5817	1N5818	1N5819	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		20	30	40	V
Non-Repetitive Peak Reverse Voltage	V _{RSM}	24	36	48	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	V
Average Rectified Forward Current (Note 1), $(V_{R(equiv)} \le 0.2 V_R(dc), T_L = 90^{\circ}C, R_{\theta JA} = 80^{\circ}C/W, P.C.$ Board Mounting, see Note 2, $T_A = 55^{\circ}C$)	Ι _Ο	1.0		A	
Ambient Temperature (Rated V _R (dc), P _{F(AV)} = 0, R _{θJA} = 80°C/W)	T _A	85	80	75	°C
Non–Repetitive Peak Surge Current, (Surge applied at rated load conditions, half–wave, single phase 60 Hz, T_L = 70°C)	I _{FSM}	FSM 25 (for one cycle)		cle)	A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T _J , T _{stg}	-65 to +125		°C	
Peak Operating Junction Temperature (Forward Current applied)	T _{J(pk)}	150		°C	

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (Note 1)

Characteristic		Max	Unit		
Thermal Resistance, Junction to Ambient	R_{\thetaJA}	80	°C/W		

ELECTRICAL CHARACTERISTICS (T_L = 25°C unless otherwise noted) (Note 1)

Characteristic		Symbol	1N5817	1N5818	1N5819	Unit
Maximum Instantaneous Forward Voltage (Note 2)	$(i_F = 0.1 A)$ $(i_F = 1.0 A)$ $(i_F = 3.0 A)$	۷F	0.32 0.45 0.75	0.33 0.55 0.875	0.34 0.6 0.9	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 2) $(T_L = 25^\circ C) \\ (T_L = 100^\circ C)$		I _R	1.0 10	1.0 10	1.0 10	mA

1. Lead Temperature reference is cathode lead 1/32 in from case.

2. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle = 2.0%.

ORDERING INFORMATION

Device	Package	Shipping [†]
1N5817	Axial Lead	1000 Units/Bag
1N5817RL	Axial Lead	5000/Tape & Reel
1N5818	Axial Lead	1000 Units/Bag
1N5818RL	Axial Lead	5000/Tape & Reel
1N5819	Axial Lead	1000 Units/Bag
1N5819RL	Axial Lead	5000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

(3)

NOTE 1. — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 V_{RWM} . Proper derating may be accomplished by use of equation (1).

$$\begin{array}{l} T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} & (1 \\ \\ \text{where } T_{A(max)} = & \text{Maximum allowable ambient temperature} \\ T_{J(max)} = & \text{Maximum allowable junction temperature} \\ & (125^{\circ}\text{C or the temperature at which thermal} \\ & \text{runaway occurs, whichever is lowest}) \\ P_{F(AV)} = & \text{Average forward power dissipation} \\ P_{R(AV)} = & \text{Average reverse power dissipation} \\ R_{\theta JA} = & \text{Junction-to-ambient thermal resistance} \end{array}$$

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_{R} = T_{J(max)} - R_{\theta JA} P_{R(AV)}$$
(2)

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_{R} - R_{\theta JA} P_{F(AV)}$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^{\circ}C$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(equiv)} = V_{in(PK)} \times F$$
 (4)

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_{A(max)}$ for 1N5818 operated in a 12–volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 0.4 \text{ A} (I_{F(AV)} = 0.5 \text{ A}), I_{(FM)}/I_{(AV)} = 10$, Input Voltage = 10 V_(rms), $R_{\theta JA} = 80^{\circ}$ C/W.

Step 4. Find $T_{A(max)}$ from equation (3). $T_{A(max)} = 109 - (80) (0.5) = 69^{\circ}C.$

**Values given are for the 1N5818. Power is slightly lower for the 1N5817 because of its lower forward voltage, and higher for the 1N5819.

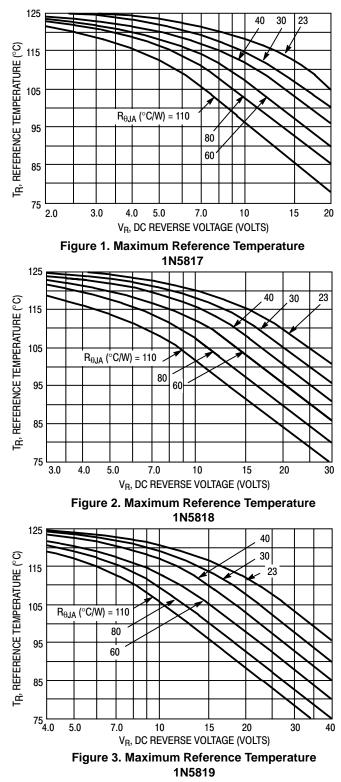


Table 1.	Table 1	. Values	for Factor F
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Half	Wave	Full Wave, Bridge		Full Wave, Ce	nter Tapped*†
Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
0.5	1.3	0.5	0.65	1.0	1.3
0.75	1.5	0.75	0.75	1.5	1.5
	Resistive 0.5	0.5 1.3 0.75 1.5	Resistive Capacitive* Resistive 0.5 1.3 0.5 0.75 1.5 0.75	ResistiveCapacitive*ResistiveCapacitive0.51.30.50.65	Resistive Capacitive* Resistive Capacitive Resistive 0.5 1.3 0.5 0.65 1.0 0.75 1.5 0.75 0.75 1.5

**Note that $V_{R(PK)} \approx 2.0 V_{in(PK)}$.

†Use line to center tap voltage for Vin.

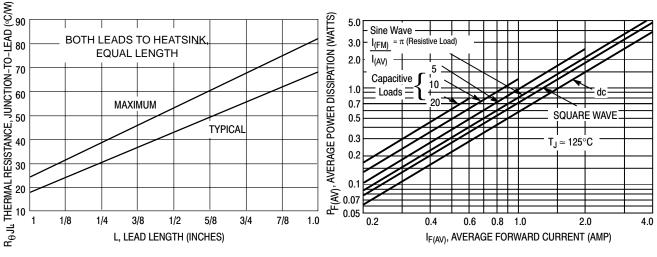
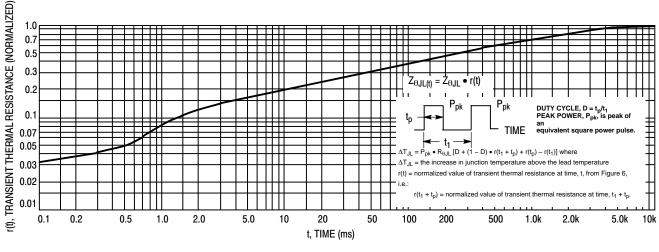
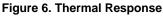




Figure 5. Forward Power Dissipation 1N5817–19





NOTE 2. — MOUNTING DATA

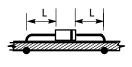
Data shown for thermal resistance junction-to-ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

Mounting	Lead Length, L (in)				
Method	1/8	1/4	1/2	3/4	R _{θJA}
1	52	65	72	85	°C/W
2	67	80	87	100	°C/W
3	50			°C/W	

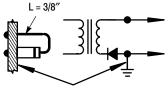
Mounting Method 1

P.C. Board with 1-1/2" x 1-1/2" copper surface.





P.C. Board with 1–1/2" x 1–1/2" copper surface.





Mounting Method 2

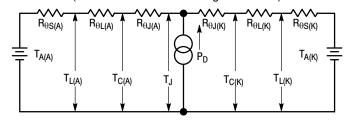
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VECTOR PIN MOUNTING

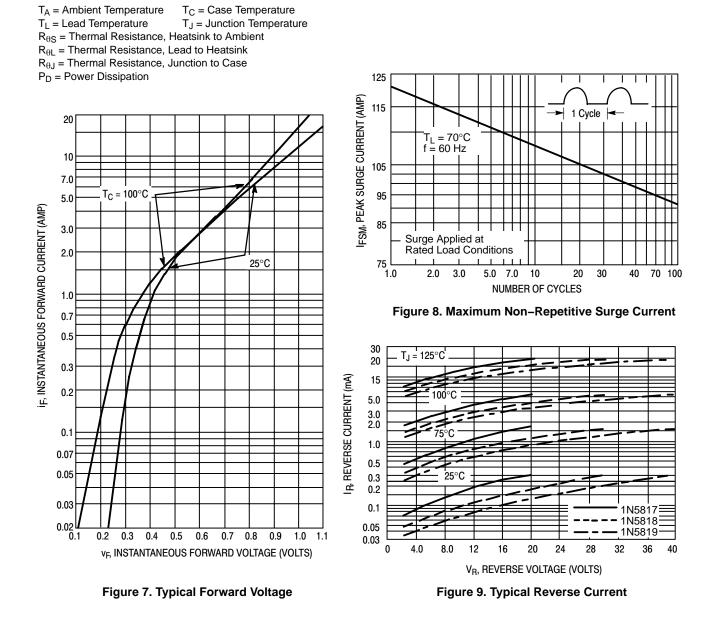
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NOTE 3. — THERMAL CIRCUIT MODEL

(For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heatsink. Terms in the model signify: (Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are: $R_{\theta L} = 100^{\circ}$ C/W/in typically and 120°C/W/in maximum $R_{\theta J} = 36^{\circ}$ C/W typically and 46°C/W maximum.



NOTE 4. — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

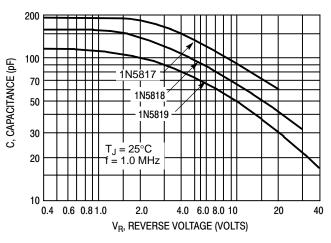
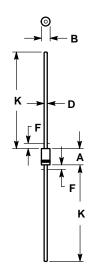


Figure 10. Typical Capacitance

PACKAGE DIMENSIONS

AXIAL LEAD, DO-41 CASE 59-10 **ISSUE S**



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 59-04 OBSOLETE, NEW STANDARD 59-09. 4. 59-03 OBSOLETE, NEW STANDARD 59-10. 5. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY 6. POLARITY DENOTED BY CATHODE BAND. 7. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.161	0.205	4.10	5.20
В	0.079	0.106	2.00	2.70
D	0.028	0.034	0.71	0.86
F		0.050		1.27
K	1.000		25.40	

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